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- **Members of the Texas Instruments** Widebus™ Family
- Operating Range 2-V to 5.5-V V_{CC}
- **EPIC™** (Enhanced-Performance Implanted **CMOS) Process**
- Distributed V_{CC} and GND Pin Configuration **Minimizes High-Speed Switching Noise**
- Flow-Through Architecture Optimizes PCB Layout
- Package Options Include Plastic 300-mil **Shrink Small-Outline (DL) and Thin Shrink** Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package **Using 25-mil Center-to-Center Spacings**

description

The 'AHC16244 are 16-bit buffers and line drivers designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. These devices provide true outputs and symmetrical active-low output-enable (OE) inputs.

The SN54AHC16244 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74AHC16244 is characterized for operation from -40°C to 85°C.

SN54AHC16244...WD PACKAGE SN74AHC16244 . . . DGG OR DL PACKAGE (TOP VIEW)

1		_	1
1 <u>0E</u> [₁ O	48	2 0E
1Y1 🛚	2	47] 1A1
1Y2 🛚	3	46	1A2
GND [4	45	GND
1Y3 🛚	5	44	1A3
1Y4 🛚	6	43] 1A4
v _{cc} [7	42	V _{CC}
2Y1 [8	41	2A1
2Y2 🛚	9	40	2A2
GND [10	39	GND
2Y3 🛚	11	38	2A3
2Y4 🛚	12	37	2A4
3Y1 🛚	13	36	3A1
3Y2 🛚	14	35	3A2
GND [15	34	GND
3Y3 🛚	16	33	3A3
3Y4 🛚	17	32	3A4
v _{cc} [18	31	V _{CC}
4Y1 🛚	19	30	4A1
4Y2	20	29	4A2
GND	21	28	GND
4Y3	22	27	4A3
4 <u>Y4</u>	23	26	4 <u>A4</u>
4OE	24	25	3 <mark>OE</mark>
	1		

FUNCTION TABLE (each buffer)

INP	JTS	OUTPUT
OE	Α	Y
L	Н	Н
L	L	L
Н	X	Z



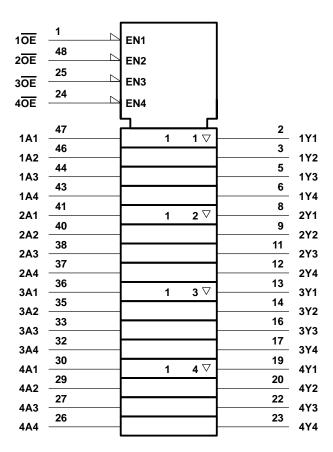
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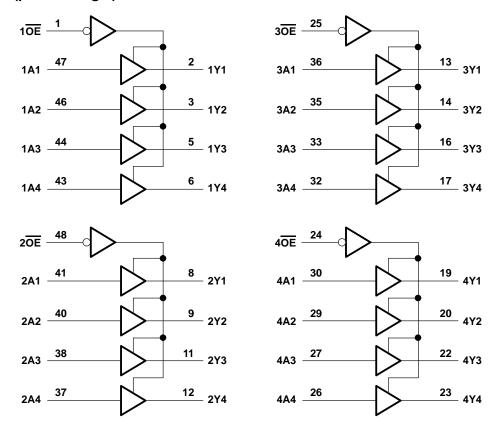
logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	
Output voltage range, V _O (see Note 1)	-0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±25 mA
Continuous current through each V _{CC} or GND	±75 mA
Package thermal impedance, θ _{JA} (see Note 2): DGG package	89°C/W
DL package	94°C/W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.



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recommended operating conditions (see Note 3)

			SN54AH	C16244	SN74AH0	C16244	UNIT	
			MIN	MAX	MIN	MAX	UNII	
VCC	Supply voltage		2	5.5	2	5.5	V	
		V _{CC} = 2 V	1.5		1.5			
V_{IH}	High-level input voltage	V _{CC} = 3 V	2.1		2.1		V	
		V _{CC} = 5.5 V	3.85		3.85			
		V _{CC} = 2 V		0.5		0.5		
V_{IL}	Low-level input voltage	V _{CC} = 3 V		0.9		0.9	V	
		V _{CC} = 5.5 V		1.65		1.65		
٧ _I	Input voltage	-	0	5.5	0	5.5	V	
۷o	Output voltage		0	Vcc	0	Vcc	V	
		V _{CC} = 2 V		-50		-50	μΑ	
loH	High-level output current	$V_{CC} = 3.3 \pm 0.3 \text{ V}$		-4		-4	A	
		$V_{CC} = 5 \pm 0.5 \text{ V}$		-8		-8	mA	
		V _{CC} = 2 V		50		50	μΑ	
loL	Low-level output current	$V_{CC} = 3.3 \pm 0.3 \text{ V}$		4		4	A	
		$V_{CC} = 5 \pm 0.5 \text{ V}$		8		8	mA	
A 4 / A		$V_{CC} = 3.3 \pm 0.3 \text{ V}$		100		100	//	
Δt/Δv	Input transition rise or fall rate	$V_{CC} = 5 \pm 0.5 \text{ V}$		20		20	ns/V	
TA	Operating free-air temperature	-	-55	125	-40	85	°C	

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	Vaa	T,	√ = 25°C	;	SN54AH0	C16244	SN74AHC16244		LINIT
		TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V	1.9	2		1.9		1.9		
		I _{OH} = -50 μA	3 V	2.9	3		2.9		2.9		
Vон			4.5 V	4.4	4.5		4.4		4.4		V
		I _{OH} = -4 mA	3 V	2.58			2.48		2.48		
		I _{OH} = -8 mA	4.5 V	3.94			3.8		3.8		
			2 V			0.1		0.1		0.1	
		I _{OL} = 50 μA	3 V			0.1		0.1		0.1	
VOL			4.5 V			0.1		0.1		0.1	0.1 V
		I _{OL} = 4 mA	3 V			0.36		0.5		0.44	
		$I_{OL} = 8 \text{ mA}$	4.5 V			0.36		0.5		0.44	
	Data inputs	V _I = V _{CC} or GND	5.5 V			±0.1		±1		±1	μΑ
Ħ	Control inputs	v1 = vCC or GND	3.5 V			±0.1		±1		±1	μΑ
loz		$V_O = V_{CC}$ or GND, $V_I (\overline{OE}) = V_{IL}$ or V_{IH}	5.5 V			±0.25		±2.5		±2.5	μΑ
ICC		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40		40	μΑ
Ci		V _I = V _{CC} or GND	5 V		2	10				10	pF
Со		$V_O = V_{CC}$ or GND	5 V		3.5						pF



PRODUCT PREVIEW

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

DADAMETED	PARAMETER FROM TO LOAD CAPACITANCE		TA	= 25°C	;	SN54AH0	16244	SN74AHC	16244	UNIT	
PARAMETER			CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
t _{PLH} *	А	Y	C _I = 15 pF		5.8	8.4	1	10	1	10	ns
tPHL*	ζ.	'	CL = 13 μ		5.8	8.4	1	10	1	10	115
^t PZH*	OE	Y	C _I = 15 pF		6.6	10.6	1	12.5	1	12.5	ns
^t PZL*	OE	•	CL = 13 μ		6.6	10.6	1	12.5	1	12.5	115
^t PHZ*	OE	Y	C _I = 15 pF		5	9.7	1	11	1	11	ns
^t PLZ*	OE	ī	CL = 15 pr		5	9.7	1	11	1	11	115
t _{PLH}	А	Y	C _I = 50 pF		8.3	11.9	1	13.5	1	13.5	ns
t _{PHL}	ζ.	•	GE = 30 bi		8.3	11.9	1	13.5	1	13.5	115
^t PZH	OE	Y	C: - 50 pE		9.1	14.1	1	16	1	16	ns
t _{PZL}	OE	ī	C _L = 50 pF		9.1	14.1	1	16	1	16	115
t _{PHZ}	ŌĒ	Y	C _I = 50 pF		10.3	14	1	16	1	16	ns
^t PLZ	OE	'	OL = 30 pr		10.3	14	1	16	1	16	115

^{*} On products compliant to MIL-PRF-38535, this parameter is ensured but not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM TO		LOAD	T	λ = 25°C	;	SN54AH0	16244	SN74AHC	16244	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	וואוט
tPLH*	Α	Y	C _I = 15 pF		3.9	5.5	1	6.5	1	6.5	ns
tPHL*	ζ	'	CL = 13 pr		3.9	5.5	1	6.5	1	6.5	10
^t PZH*	ŌĒ	Y	C _I = 15 pF		4.7	7.3	1	8.5	1	8.5	ns
tPZL*	OE	'	CL = 13 pr		4.7	7.3	1	8.5	1	8.5	10
^t PHZ*	ŌE	Y	C _L = 15 pF		5	7.2	1	8.5	1	8.5	ns
^t PLZ*	OE	'	GL = 13 pr		5	7.2	1	8.5	1	8.5	115
t _{PLH}	А	Y	C _I = 50 pF		5.4	7.5	1	8.5	1	8.5	ns
t _{PHL}	ζ	'	GL = 30 pr		5.4	7.5	1	8.5	1	8.5	10
^t PZH	ŌĒ	Y	C _I = 50 pF		6.2	9.3	1	10.5	1	10.5	ns
t _{PZL}	OE	'	GL = 30 pr		6.2	9.3	1	10.5	1	10.5	110
t _{PHZ}	ŌĒ	Y	C: - 50 pE		6.7	9.2	1	10.5	1	10.5	ns
t _{PLZ})L	1	C _L = 50 pF		6.7	9.2	1	10.5	1	10.5	115

^{*} On products compliant to MIL-PRF-38535, this parameter is ensured but not production tested.

output-skew characteristics, C_L = 50 pF (see Note 4)

	PARAMETER		SN74AH	C16244	
			T _A = 25°C	MIN MAX	UNIT
			MIN MAX	WIIN WAX	
	Output skew	$3.3~V\pm0.3~V$	1.5	1.5	
tsk(o)	Output skew	5 V ± 0.5 V	1	1	ns

NOTE 4: Characteristics are determined during product characterization and ensured by design.



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noise characteristics, V_{CC} = 5 V, C_L = 50 pF, T_A = 25°C (see Note 5)

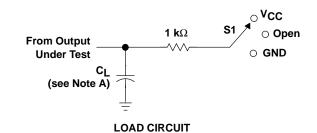
	PARAMETER			SN74AHC16244			
	PARAMETER		TYP	MAX	UNIT		
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.5		V		
V _{OL} (V)	Quiet output, minimum dynamic V _{OL}		-0.2		V		
VOH(V)	Quiet output, minimum dynamic VOH		4.8		V		
VIH(D)	High-level dynamic input voltage	3.5			V		
V _{IL(D)}	Low-level dynamic input voltage			1.5	V		

NOTE 5: Characteristics are determined during product characterization and ensured by design for surface-mount packages only.

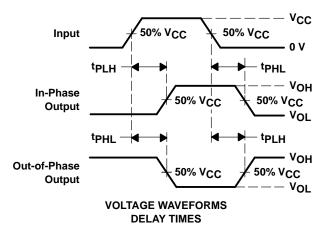
operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

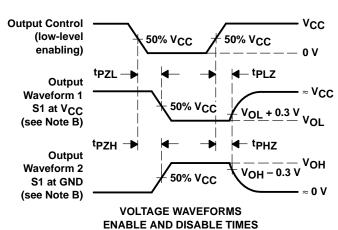
	PARAMETER		ONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load,	f = 1 MHz	8.6	pF

PARAMETER MEASUREMENT INFORMATION



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	VCC
tPHZ/tPZH	GND





NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f = 3$ ns. $t_f = 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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